ASSOCIATION CONNE	Material Comp © Copyright 2005. I international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Type http://www.ipc.org/IPC-175x  Form Type Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				rials and N	ials and Mfg Information				
Supplier Info	ormation				·										
Company name*			Company unique ID			τ	Unique ID Authority				Respor	Response Date*			
nsemi										2024-0	2024-05-11				
Contact Name		Title - Contact			1	Phone - Contact*				Email -	Email - Contact*				
Product-Env-St	tewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Rep	oresentative*	Title - Representative			1	Phone - Representative*				Email -	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requ	uester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	e Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP813	NCP81382MNTXG Integrated Driver		and MOSFET	MOSFET 2		4-05-11 PH		PHA		101.13	mg	Each	
Ianufacturi	ing Proccess Informa	tion													
Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature		re Max Time at Pea	k Tempera	ature Numb	er of Reflow Cyc	eles			
Matte Tin (Sn) - annealed C			CU Alloy 3			<b>260</b> C		30	seco	nds 3					
omments															
TTENTION: N	MSL 3 Rated item require	es Bake and D	ry Pack (after	r electrical test)											
or more inforn	nation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
cadmium, hexavalentchromium, polybrominal contains a RoHS restricted substance inexcess encompass all such components. Supplier certi as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided by certification in this paragraph. If the Company	ted biphenyls and/or polybrominated dipheny of an applicable quantity limit, please indicate fies that it gathered the information it provident. Supplier acknowledges that Company will we relied on information provided by others in the supplier agrees that, at a minimum and the Supplier enter into a written agreements ource of the Supplier's liability and the Com-	2011/65/EU and implemented by the laws of the End ethers (each a "RoHS restricted substance") in except the below which, if any, RoHS exemption you believe in this form using appropriate methods to ensure rely on this certification in determining the compliant completing this form, and that Supplier may not have its suppliers have provided certifications regarding ent with respect to the identified part, the terms and capany's remedies for issues that arise regarding information in the provided certification in the supplier is such part shall apply.	sess of the applicable quantity limit identified able may apply. If the part is an assembly with low its accuracy and that such information is true annee of its products with European Union member ave independently verified such information. However, their contributions to the part, and those certifications of that agreement, including any warr	bove. If a homogeneous material within the part ver level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. It is involved in situations where Supplier has not ations are at least as comprehensive as the ranty rights and/or remedies provided as part of							
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	astislav Drska	-En									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.02	mg	Supplier	Silicon (Si)	7440-21-3		3.02	mg
Die Attach Solder	5.35	mg	Supplier	Silver (Ag)	7440-22-4		0.1338	mg
			A	Lead (Pb)	7439-92-1	7a	4.9488	mg
			Supplier	Tin (Sn)	7440-31-5		0.2675	mg
Lead Frame	59.54	mg	Supplier	Silver (Ag)	7440-22-4		0.9824	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0714	mg
			Supplier	Iron (Fe)	7439-89-6		1.3992	mg
			Supplier	Copper (Cu)	7440-50-8		57.0691	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0179	mg
Mold Compound-Black	31.34	mg	Supplier	Epoxy resins	129915-35-1		1.567	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.567	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1254	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7208	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.639	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.7208	mg
Plating	1.57	mg	Supplier	Tin (Sn)	7440-31-5		1.57	mg
Wire Bond - Au	0.31	mg	Supplier	Gold (Au)	7440-57-5		0.31	mg